Tota	l No.	of Questions : 8] SEAT No. :	
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_		[5461] > 569	
		B.E. (E & TC) (Elective - II)	
		Electronic Product Design	
		(2015 Pattern)	
Time	2:2 1/2	[Max. 1	Marks : 70
		ons to the candidates:	
	1)	Neat diagrams must be drawn wherever necessary.	
	2)	Figures to the right indicate full marks.	
	3)	Attempt Q.No. 1 or 2, Q.No. 3 or 4, Q.No 5 or 6 & Q.No. 7 or 8.	
Q1)	a)	Discuss noise coupling mechanisms and how to minimize thes	e at circuit
		board	[6]
	b)	What is the significance functional model? Explain with example	ple. <b>[6]</b>
	c)	In finding software faults in real time embedded system explain the	ne features
	1	and limitations of debugger, simulator and emulators.	[8]
		OR	
<i>Q2)</i>	a)	What is need of shielding explain with suitable example?	[6]
	b)	What is importance of design specifications in product design	n? [6]
	c)	Explain different stages in software development at which	bugs may
		enter and list common bugs and ways to eliminate them.	[8]
			Ó
<i>Q3)</i>	a)	What are different sources of ESD and how to minimize ESD	). [8]
	b)	Write a short note on followings:	[10]
		i) Radiated and conducted Immunity.	· Ko
		ii) Grounding methodologies in PCB design.	<b>&gt;</b> .
		OR Or	r
O(1)	a)	Evnlain PCB termination techniques for high frequency design	n [6]

Explain PCB termination techniques for high frequ [6] Write a note on Critical Frequencies of PCB. [6] b) What are the design techniques used to prevent crosstalk. **[6]** c) Explain how different blocks are partitioned in complicated circuit. [6] **Q5**) a) Explain how conducted EMI and radiated EMI originate. b) What are the different steps in the debugging? Differentiate the c) troubleshooting from debugging? **[6]** *P.T.O.* 

		OR %	
Q6)	a)	State importance of EMI/EMC test and give typical set up.	[8]
	b)	Compare different types of ADCs with respect to resolution, pow	er
		consumption, multiple inputs and nonlinearity.	<b>[8</b> ]
<b>Q7</b> )	a)	Explain in brief accountability and liability of documents in product design	gn.
			[8]
	b)		[8]
		OR	
<b>Q8</b> )	a)		[8]
	b)		[8]
		i) Engineering notebook.	
		ii) Service manual.	
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